



REVERSE VOLTAGE: 50 - 1000 V

CURRENT: 1.0 A



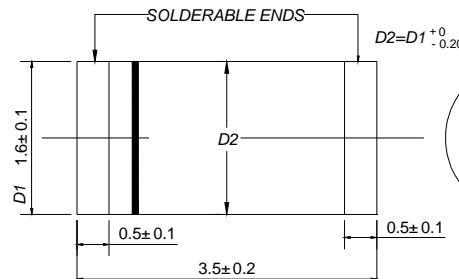
Features

- ❖ Plastic package has underwriters laboratory flammability classifications
- ❖ For surface mounted applications
- ❖ Low profile package
- ❖ Built-in strain relief, ideal for automated placement
- ❖ Glass passivated chip junction
- ❖ High temperature soldering:
250°C/10 seconds at terminals

Mechanical Data

- ❖ Case: JEDEC DO-213AA, molded plastic over passivated chip
- ❖ Polarity: Color band denotes cathode end
- ❖ Weight: 0.0014 ounces, 0.036 gram

DO - 213AA



Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

		GL1A	GL1B	GL1D	GL1G	GL1J	GL1K	GL1M	UNITS
Maximum recurrent peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RWS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current @T _L =75 °C	I _{F(AV)}					1.0			A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}					30			A
Maximum instantaneous forward voltage at 1.0 A	V _F			1.2			1.3		V
Maximum DC reverse current @T _A =25°C at rated DC blocking voltage @T _A =125°C	I _R				5.0				µA
					50.0				
Typical junction capacitance(NOTE 2)	C _J			4.0					pF
Typical reverse recovery time(NOTE3)	t _{rr}			1.5					µS
Typical thermal resistance (NOTE 4)	R _{θJA}			150					°C/W
Operating junction temperature range	T _J			-55-----+150					°C
Storage temperature range	T _{STG}			-55-----+150					°C

NOTE: 1. Measured at 1.0MHz and applied reverse voltage of 4.0volts

2. Thermal resistance from junction to ambient and junction to lead PCB mounted on 0.27"X0.27"(7.0X7.0mm²) copper pad areas.

Ratings AND Characteristic Curves

FIG.1 – FORWARD DERATING CURVE

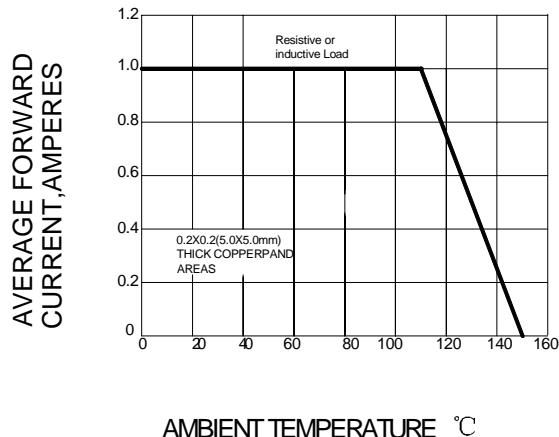


FIG.2 PEAK FORWARD SURGE CURRENT

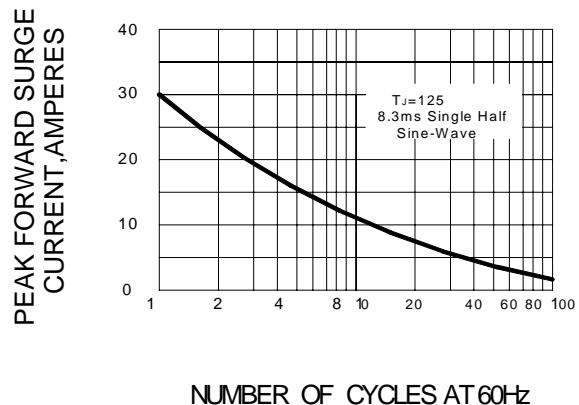


FIG.3 – TYPICAL FORWARD CHARACTERISTICS

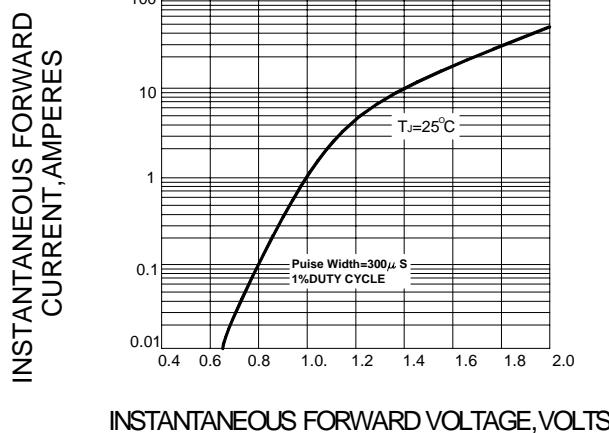


FIG.4 – TYPICAL REVERSE CHARACTERISTICS

